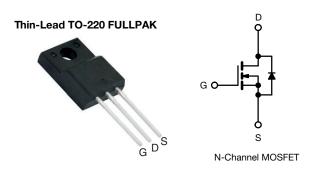
# SiHA22N60EF



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# **EF Series Power MOSFET With Fast Body Diode**



PRODUCT SUMMARY				
V <sub>DS</sub> (V) at T <sub>J</sub> max.	650			
R <sub>DS(on)</sub> typ. (Ω) at 25 °C	$V_{GS} = 10 V$	0.158		
Q <sub>g</sub> max. (nC)	96			
Q <sub>gs</sub> (nC)	9			
Q <sub>gd</sub> (nC)	21			
Configuration	Single			

## **FEATURES**

- Low figure-of-merit (FOM) Ron x Qa
- Low input capacitance (Ciss)
- · Reduced switching and conduction losses
- Ultra low gate charge (Q<sub>q</sub>)
- Avalanche energy rated (UIS)
- · Material categorization: for definitions of compliance please see www.vishay.com/doc?99912

### **APPLICATIONS**

- Server and telecom power supplies
- Switch mode power supplies (SMPS)
- Power factor correction power supplies (PFC)
- Lighting
  - High-intensity discharge (HID)
  - Fluorescent ballast lighting
- Industrial
  - Welding
  - Induction heating
  - Motor drives
  - Battery chargers
  - Renewable energy
  - Solar (PV inverters)

ORDERING INFORMATION				
Package	Thin-Lead TO-220 FULLPAK			
Lead (Pb)-free and halogen-free	SiHA22N60EF-GE3			

PARAMETER	SYMBOL	LIMIT	UNIT	
Drain-source voltage	V <sub>DS</sub>	600		
Gate-source voltage	V <sub>GS</sub>	± 30	- V	
Continuous drain surrent $(T_{1} - 150 ^{\circ}\text{C})^{\frac{1}{2}}$	$V_{GS} \text{ at } 10 \text{ V} \qquad \frac{T_{C} = 25 \text{ °C}}{T_{C} = 100 \text{ °C}}$	L_	19	А
Continuous drain current ( $T_J = 150 \ ^\circ C$ ) $^e$	$T_{\rm C} = 100 ^{\circ}{\rm C}$	I <sub>D</sub>	12	
Pulsed drain current <sup>a</sup>	I <sub>DM</sub>	46		
Linear derating factor		0.26	W/°C	
Single pulse avalanche energy <sup>b</sup>	E <sub>AS</sub>	144	mJ	
Maximum power dissipation	PD	33	W	
Operating junction and storage temperature range	T <sub>J</sub> , T <sub>stg</sub>	-55 to +150	°C	
Drain-source voltage slope	T <sub>J</sub> = 125 °C	al / alt	70	
Reverse diode dv/dt <sup>d</sup>	dv/dt	50	V/ns	
Soldering recommendations (peak temperature) <sup>c</sup>	For 10 s		260	°C
Mounting torque, M3 screw	•		0.6	Nm

#### Notes

a. Repetitive rating; pulse width limited by maximum junction temperature

b.  $V_{DD}$  = 140 V, starting T<sub>J</sub> = 25 °C, L = 28.2 mH, R<sub>g</sub> = 25  $\Omega$ , I<sub>AS</sub> = 3.2 A

c. 1.6 mm from case

d.  $I_{SD} \leq I_D$ , di/dt = 400 A/µs, starting  $T_J$  = 25 °C

e. Limited by maximum junction temperature

S19-0120-Rev. A, 04-Feb-2019



COMPLIANT

HALOGEN

FREE



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THERMAL RESISTANCE RAT	INGS						
PARAMETER	SYMBOL	TYP.	M	AX.	UNIT		
Maximum junction-to-ambient	R <sub>thJA</sub>	-	6	65		00.001	
Maximum junction-to-case (drain)	R <sub>thJC</sub>	-	3	.8	°C/W		
<b>SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C,	unless otherwi	se noted)					
PARAMETER	SYMBOL	TES	T CONDITIONS	MIN.	TYP.	MAX.	UNI
Static							
Drain-source breakdown voltage	V <sub>DS</sub>	V <sub>GS</sub> =	= 0 V, I <sub>D</sub> = 250 μA	600	-	-	V
V <sub>DS</sub> temperature coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I <sub>D</sub> = 1 mA	-	0.68	-	V/°C
Gate-source threshold voltage (N)	V <sub>GS(th)</sub>	V <sub>DS</sub> =	- V <sub>GS</sub> , I <sub>D</sub> = 250 μΑ	2.0	-	4.0	V
Osta asumas laskana			$V_{GS} = \pm 20 \text{ V}$		-	± 100	nA
Gate-source leakage	I <sub>GSS</sub>	$V_{GS} = \pm 30 \text{ V}$		-	-	± 1	μA
	I <sub>DSS</sub>	V <sub>DS</sub> = 480 V, V <sub>GS</sub> = 0 V		-	-	1	μA
Zero gate voltage drain current		V <sub>DS</sub> = 480 V, V <sub>GS</sub> = 0 V, T <sub>J</sub> = 125 °C		) -	-	500	
Drain-source on-state resistance	R <sub>DS(on)</sub>	V <sub>GS</sub> = 10 V I <sub>D</sub> = 11 A		-	0.158	0.182	Ω
Forward transconductance <sup>a</sup>		V <sub>DS</sub> = 30 V, I <sub>D</sub> = 11 A		-	5.8	-	S
Dynamic						•	
Input capacitance	C <sub>iss</sub>	V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 100 V,		-	1423	-	-
Output capacitance	C <sub>oss</sub>			-	73	-	
Reverse transfer capacitance	C <sub>rss</sub>	1	f = 1 MHz		5	-	
Effective output capacitance, energy related <sup>a</sup>	C <sub>o(er)</sub>	$V_{DS}$ = 0 V to 480 V, $V_{GS}$ = 0 V		-	48	-	pF
Effective output capacitance, time related <sup>b</sup>	C <sub>o(tr)</sub>			-	240	-	
Total gate charge	Qg	V <sub>GS</sub> = 10 V I <sub>D</sub> = 11 A, V <sub>DS</sub> = 480 V		-	48	96	
Gate-source charge	Q <sub>gs</sub>			V -	9	-	nC
Gate-drain charge	Q <sub>gd</sub>			-	21	-	
Turn-on delay time	t <sub>d(on)</sub>	$V_{DD} = 480 \text{ V}, \text{ I}_{D} = 11 \text{ A},$ $V_{GS} = 10 \text{ V}, \text{ R}_{g} = 9.1 \Omega$		-	15	30	
Rise time	t <sub>r</sub>			-	21	42	- ns
Turn-off delay time	t <sub>d(off)</sub>			-	58	87	

f = 1 MHz, open drain

 $T_{J} = 25$  °C,  $I_{S} = 11$  A,  $V_{GS} = 0$  V

 $\begin{array}{l} T_J=25~^\circ C,~I_F=I_S=11~A,\\ di/dt=100~A/\mu s,~V_R=400~V \end{array}$ 

MOSFET symbol

showing the

integral reverse p - n junction diode

Notes

Gate input resistance

**Drain-Source Body Diode Characteristics** 

Continuous source-drain diode current

Pulsed diode forward current

Diode forward voltage

Reverse recovery time

Reverse recovery charge

Reverse recovery current

Fall time

a.  $C_{oss(er)}$  is a fixed capacitance that gives the same energy as  $C_{oss}$  while  $V_{DS}$  is rising from 0 % to 80 %  $V_{DSS}$ 

t<sub>f</sub>

Rg

 $I_S$ 

 $I_{SM}$ 

V<sub>SD</sub>

t<sub>rr</sub>

Q<sub>rr</sub>

I<sub>RRM</sub>

b. C<sub>oss(tr)</sub> is a fixed capacitance that gives the same charging time as C<sub>oss</sub> while V<sub>DS</sub> is rising from 0 % to 80 % V<sub>DSS</sub>

Document Number: 92250

Ω

А

V

ns

μC

A

-

0.3

\_

\_

-

\_

\_

\_

25

0.6

\_

\_

\_

113

0.7

11

50

1.2

19

46

1.2

226

1.4

-



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## TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

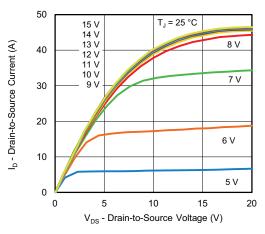


Fig. 1 - Typical Output Characteristics

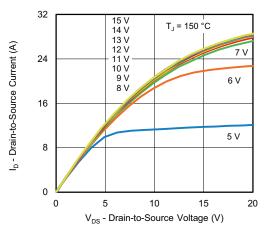


Fig. 2 - Typical Output Characteristics

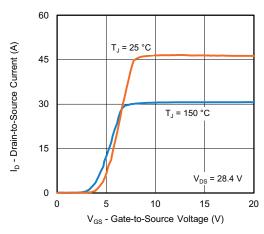


Fig. 3 - Typical Transfer Characteristics

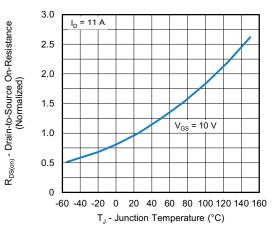


Fig. 4 - Normalized On-Resistance vs. Temperature

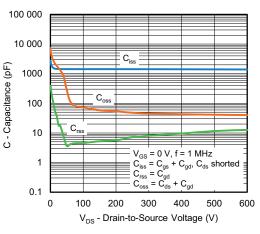
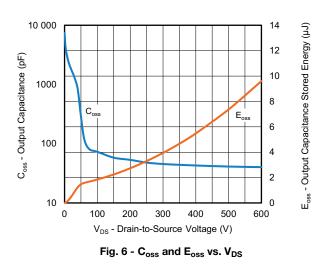


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage



S19-0120-Rev. A, 04-Feb-2019

**3** For technical questions, contact: <u>hvm@vishav.com</u>

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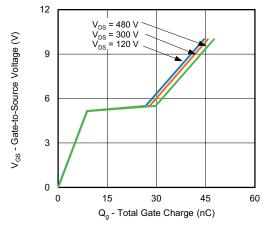


Fig. 7 - Typical Gate Charge vs. Gate-to-Source Voltage

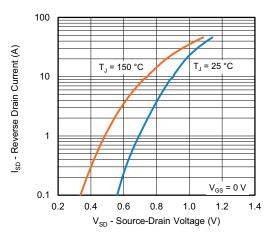


Fig. 8 - Typical Source-Drain Diode Forward Voltage

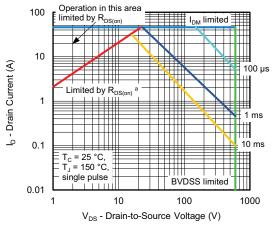


Fig. 9 - Maximum Safe Operating Area

Note

a.  $V_{GS}$  > minimum  $V_{GS}$  at which  $R_{DS(on)}$  is specified

4

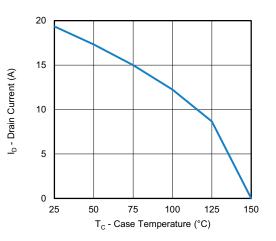


Fig. 10 - Maximum Drain Current vs. Case Temperature

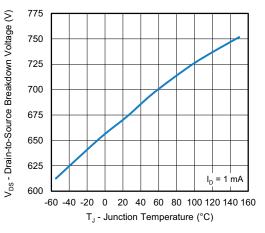
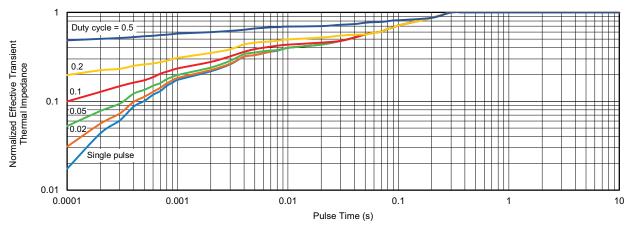


Fig. 11 - Temperature vs. Drain-to-Source Voltage



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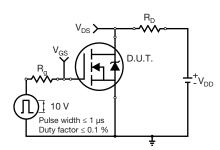


Fig. 13 - Switching Time Test Circuit

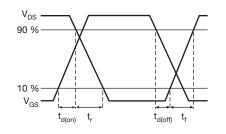


Fig. 14 - Switching Time Waveforms

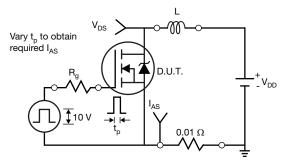


Fig. 15 - Unclamped Inductive Test Circuit

S19-0120-Rev. A, 04-Feb-2019

 $V_{DD}$  $V_{DS}$ 

Fig. 16 - Unclamped Inductive Waveforms

I<sub>AS</sub>

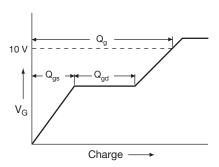


Fig. 17 - Basic Gate Charge Waveform

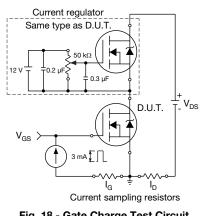
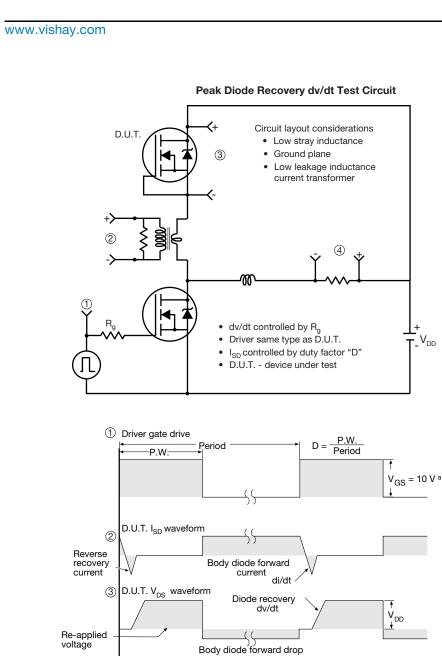


Fig. 18 - Gate Charge Test Circuit

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5



Inductor current

4

Note

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Fig. 19 - For N-Channel

Ripple ≤ 5 %

a.  $V_{GS} = 5$  V for logic level devices

↑ I<sub>SD</sub>

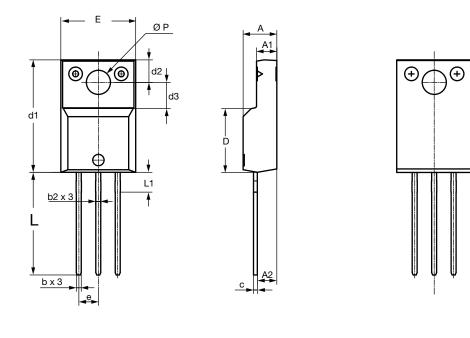
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# **TO-220 FULLPAK Thin Lead**





		DIMEN	ISIONS	
SYMBOL	MILLIN	METERS	INC	HES
	MIN.	MAX.	MIN.	MAX.
А	4.30	4.70	0.169	0.185
A1	2.50	2.90	0.098	0.114
A2	2.40	2.80	0.094	0.110
b	0.60	0.80	0.024	0.031
b2	0.60	0.90	0.024	0.035
С	-	0.60	-	0.024
D	8.30	8.70	0.327	0.342
d1	14.70	15.30	0.579	0.602
d2	2.90	3.10	0.114	0.122
d3	3.30	3.70	0.130	0.146
E	9.70	10.30	0.382	0.406
е	2.50	2.70	0.098	0.106
L	13.40	13.80	0.528	0.543
L1	1.00	2.80	0.039	0.110
ØP	3.00	3.40	0.118	0.134
ECN: E20-0684-Rev. D, 28 DWG: 6021	3-Dec-2020	·	·	

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